**2017 SCHOLARSHIP APPLICATION FORM**

**Full Legal Name:**

**Home Address:**

Number and Street Apt. No.

City State Zip Code Daytime Phone Number

**Mailing Address** (if different from above)**:**

Number and Street Apt. No.

City State Zip Code Daytime Phone Number

**E-Mail Address:**

**College Applied-To, Accepted-at, Attending** (circle one)**:**

**Major** (circle one)**:** Engineering / Architecture / Construction Management

**Anticipated College Graduation Date**:

**What is your cumulative Grade Point Average (state whether 4.0 or 5.0 scale) to-date, including the most recently completed semester/quarter?**

**Signature** **Date**

This signature certifies that the information provided is true and correct.

**2017 SCHOLARSHIP APPLICATION**

**Attach the following items to this application:**

1. A copy of your high school or college transcript (to-date).
2. List your extracurricular activities, including Honors and Awards. Please restrict them to periods of High School and College attendance. Include offices held or similar leadership positions. **This is limited to one page.** (Times New Roman 12 point font with 1” margins)
3. A copy of your SAT / ACT scores.
4. Letters of recommendation (*at least one, but no more than three*) from college advisor, academic instructor, immediate supervisor, religious leader, or other adult (*that is not related to you*) that can personally attest to your character and leadership qualities. Letters should be signed and no more than one page in length.
5. 500 word essay on either topic: “Why I Want to Study in the Field of [.........]” or “The Contributions I Want to make to the Field of [........].” Substitute your (proposed) college major in the [.......] blank. The scholarship committee will be looking for the quality of the essay, not the length. The 500 words is a guideline, **essay should not be more than one page in length**. (Times New Roman 12 point font with 1” margins)

**Deadline for receipt of application is Friday, April 14, 2017**

All applications must be submitted electronically as one single PDF file. Each package must include the following items, in the order listed below:

* 2017 Application Form (signed)
* Listing of extracurricular activities (1 page max)
* Copy of SAT/ACT scores
* Letters of recommendation (min 1, max 3 – each letter 1 page max)
* Essay (1 page max)

Submit Application Packages as a single PDF file to: john.slaughter@tetratech.com

Use a Subject line of:

**"SAME Scholarship (Applicant Last Name)"**